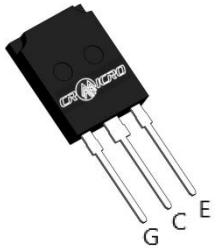
General Description：

Using owner proprietary trench design and advanced Field Stop (FS) technology, offering superior conduction and Switching performances. RoHS Compliant.

V_{CES}	650	V
I_C	160	A
P_{tot} (T_C=25℃)	750	W
$V_{CE(sat)}$	1.40	V

Outline ： TO-247PLUS

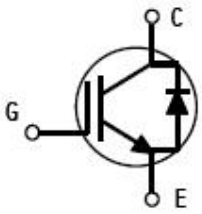


Features：

- FS Trench Technology, Positive temperature coefficient
- Low saturation voltage：

  $V_{CE(sat)}$,TYP=1.40V @I_C=160A,V_{GE}=15V；

Inner Circuit:



Applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

Package Parameters

Type	Marking	Package	Packing	Qty
CRG160T65AX7HDZ	G160T65AX7HDZ	TO-247PLUS	Tube	25

Absolute Maximum Ratings（T_C= 25℃ unless otherwise specified）：

Symbol	Parameter	Rating	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate- Emitter Voltage	±20	V
V_{GES}	Gate- Emitter Voltage（tp≤10us,D<0.01）	±30	V
I_C[a1]	Collector Current @T_C = 25 °C	180	A
	Collector Current @T_C = 100 °C	180	
I_{CM}	Pulsed Collector Current	600	A
I_F[a2]	Diode Continuous Forward Current @T_C =25 °C	180	A
	Diode Continuous Forward Current @T_C = 100 °C	160	
I_{FM}	Diode Maximum Forward Current	600	A
P_D	Power Dissipation @ T_C = 25°C	750	W
	Power Dissipation @ T_C = 100°C	375	W
T_j[a3]	Operating Junction temperature range	-40～175	℃
T_{stg}	Storage Temperature Range	-55～150	℃
T_L	Maximum Temperature for Soldering	270	℃

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R\theta_{JC}$	Thermal Resistance, Junction to case for IGBT	--	0.22	℃/W
$R\theta_{JC}$	Thermal Resistance, Junction to case for Diode	--	0.30	℃/W
$R\theta_{JA}$	Thermal Resistance, Junction to Ambient	--	40	℃/W

Electrical Characteristics of the IGBT（T_C= 25℃ unless otherwise specified）：

Symbol	Parameter	Conditions	Value			Unit
			Min	Typ	Max	
OFF Characteristics						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	V_{GE}=0V,I_{CE}=250uA	650	--	--	V
I_{CES}	Collector Cut-off Current	V_{GE}=0V,V_{CE}=650V	--	--	1	mA
$I_{GES(F)}$	Gate-Emitter Forward Leakage Current	V_{GE}=+20V	--	--	+250	nA
$I_{GES(R)}$	Gate-Emitter Reverse Leakage Current	V_{GE} =-20V	--	--	-250	nA
ON Characteristics						
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C=160A ,V_{GE}=15V @ T_C = 25°C	--	1.40	2.4	V
		I_C=160A ,V_{GE}=15V @ T_C =175°C	--	1.65	--	V
$V_{GE(th)}$	Gate - Emitter Threshold Voltage	I_C=1.5mA ,V_{CE}=V_{GE}	3.0	4.6	6.0	V
Pulse width tp≤300μs,δ≤2%						

Dynamic Characteristics							
C_{ies}	Input Capacitance	V_{CE}=25V,V_{GE}=0V f=1MHz		--	12335	--	pF
C_{oes}	Output Capacitance			--	346	--	
C_{res}	Reverse Transfer Capacitance			--	69	--	
Switching Characteristics							
$t_{d(on)}$	Turn-on Delay Time	V_{CE}=400V,I_C=160A, R_g=10Ω,V_{GE}=15V, Inductive Load, T_J=25℃		--	50	--	ns
t_r	Rise Time			--	102	--	
$t_{d(off)}$	Turn-Off Delay Time			--	709	--	
t_f	Fall Time			--	134	--	
E_{on} [a4]	Turn-On Switching Loss			--	5.9	--	mJ
E_{off}	Turn-Off Switching Loss			--	6.4	--	
E_{ts}	Total Switching Loss			--	12.3	--	
$t_{d(on)}$	Turn-on Delay Time	V_{CE}=400V,I_C=160A, R_g=10Ω,V_{GE}=15V, Inductive Load, T_J=175℃		--	42	--	ns
t_r	Rise Time			--	86	--	
$t_{d(off)}$	Turn-Off Delay Time			--	812	--	
t_f	Fall Time			--	112	--	
E_{on} [a4]	Turn-On Switching Loss			--	7.0	--	mJ
E_{off}	Turn-Off Switching Loss			--	6.3	--	
E_{ts}	Total Switching Loss			--	13.3	--	
Qg	Total Gate Charge	V_{CE}=520V,I_C=160A, V_{GE}=15V,		--	634	--	nC
Qge	Gate to Emitter Charge			--	73	--	
Qgc	Gate to Collector Charge			--	245	--	
Electrical Characteristics of the DIODE							
V_F	Diode Forward Voltage	I_F=160A	TC=25℃	--	1.95	3.2	V
			TC=175℃	--	1.9	--	V
t_{rr}	Reverse Recovery Time	V_R=400V, R_g=10Ω, I_F=160A	TC=25℃	--	136	--	ns
			TC=175℃	--	243	--	
Q_{rr}	Reverse Recovery Charge		TC=25℃	--	2.7	--	uC
			TC=175℃	--	10.6	--	
I_{rrm}	Reverse Recovery Current		TC=25℃	--	34	--	A
			TC=175℃	--	75	--	
dif/dt	Diode Current Slope		TC=25℃	--	1340	--	A/us
			TC=175℃	--	1330	--	
Erec	Reverse Recovery Energy		TC=25℃	--	645	--	uJ
			TC=175℃	--	2505	--	

Notes：

a1：The collector DC current is limited by the maximum junction temperature, limited by the bond wire current capacity at 25° C

a2：FRD DC forward current is limited by the maximum junction temperature, limited by the bond wire current capacity at 25° C

a3：Repetitive rating; pulse width limited by maximum junction temperature; Under overloading conditions, it is allowed to operate under the maximum junction temperature T_j=175℃, and the maximum duty cycle is less than 20% (maximum lasting 60s)

a4：Turn-on losses include diode losses

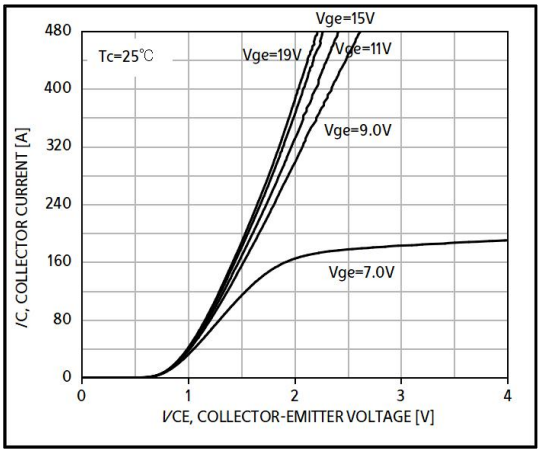


Figure 1. Output Characteristics

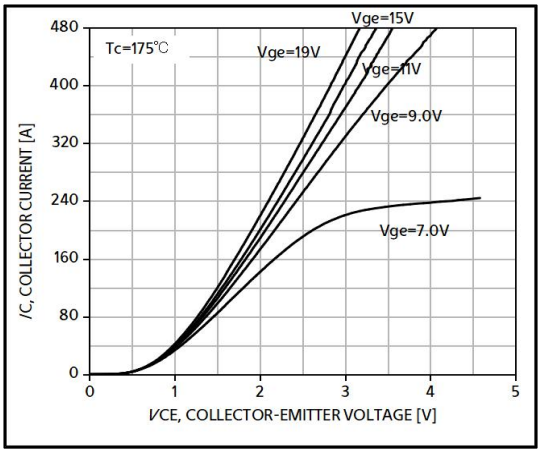


Figure 2. Output Characteristics

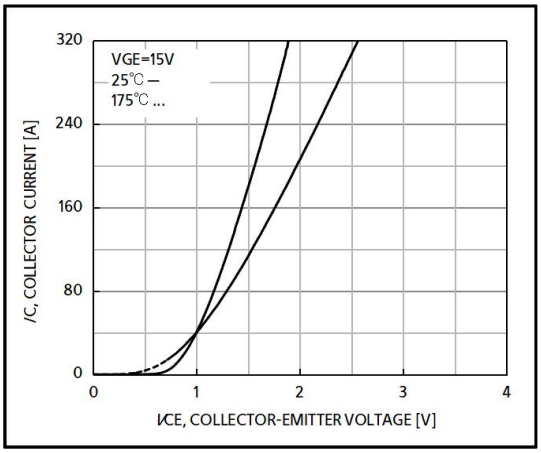


Figure 3. Saturation Voltage Characteristics

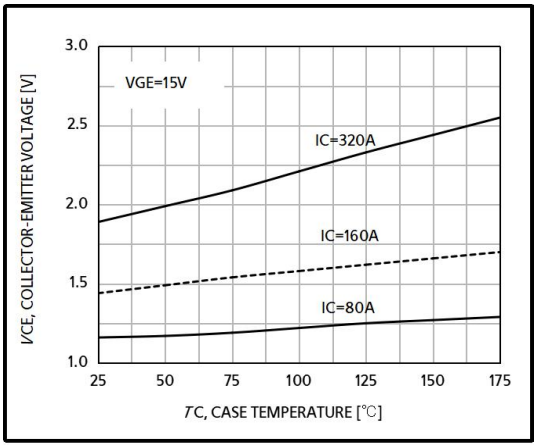


Figure 4. Saturation Voltage -T_C Characteristics

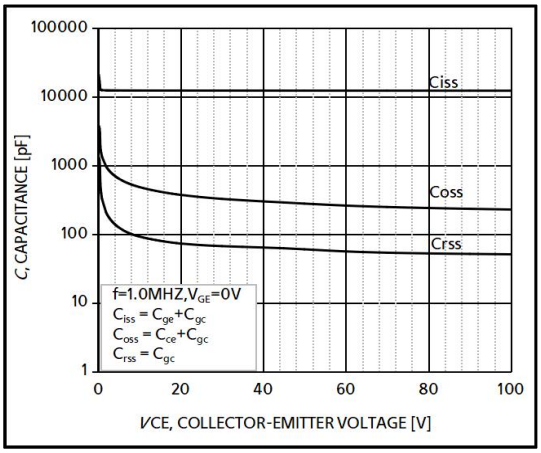


Figure 5. Capacitance Characteristics

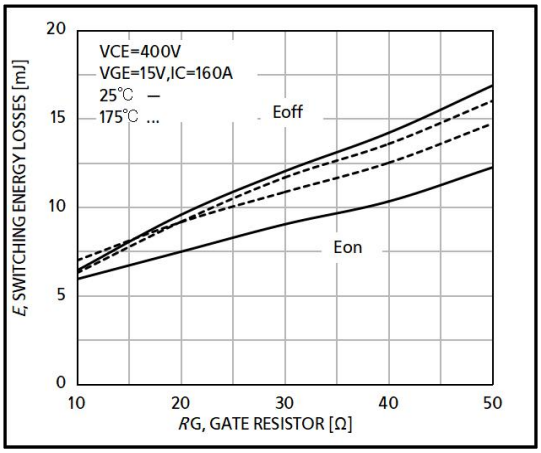


Figure 6. Switching Loss-R_G Characteristics

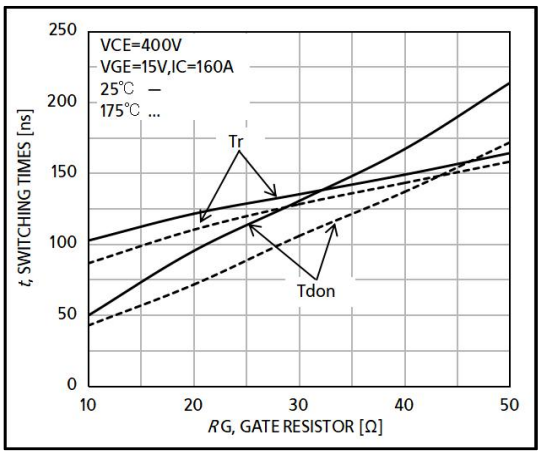


Figure 7. Switching Time-R_G Characteristics

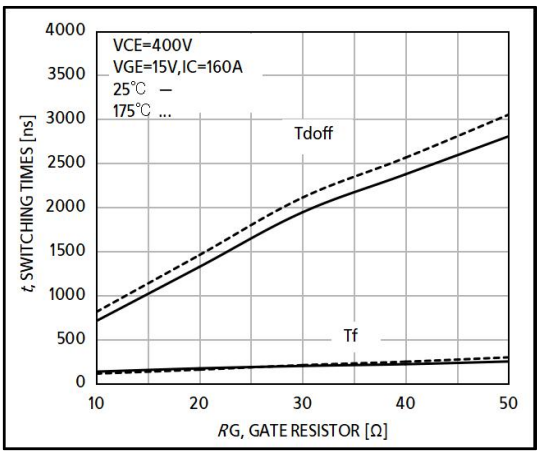


Figure 8. Switching Time-R_G Characteristics

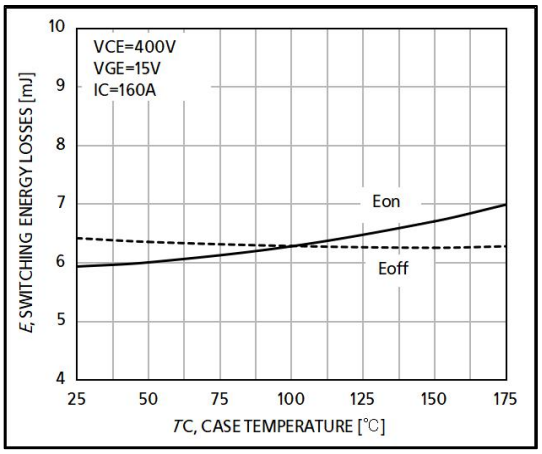


Figure 9. Switching Loss-Tc Characteristics

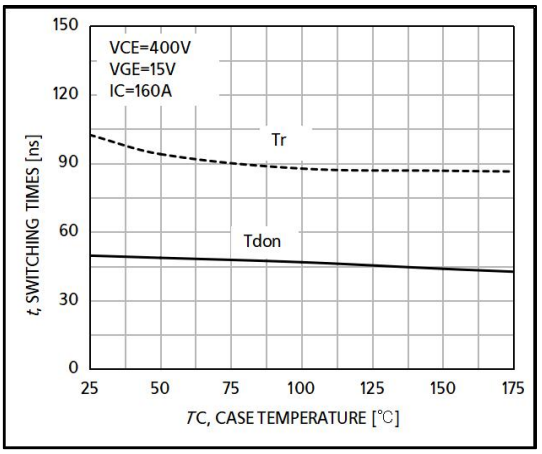


Figure 10. Switching Time-Tc Characteristics

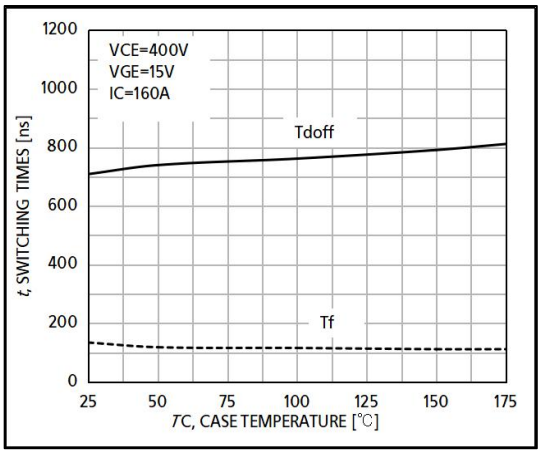


Figure 11. Switching Time-Tc Characteristics

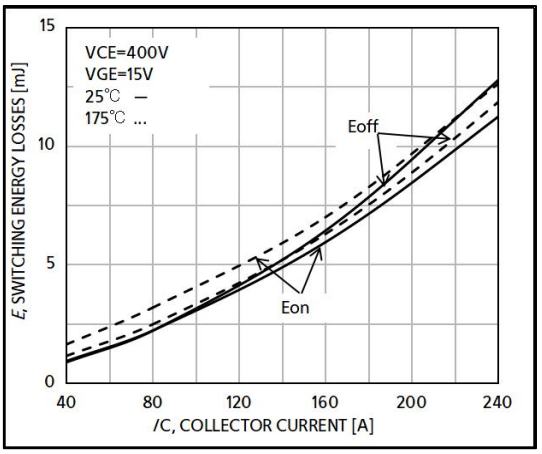


Figure 12. Switching Loss-I_C Characteristics

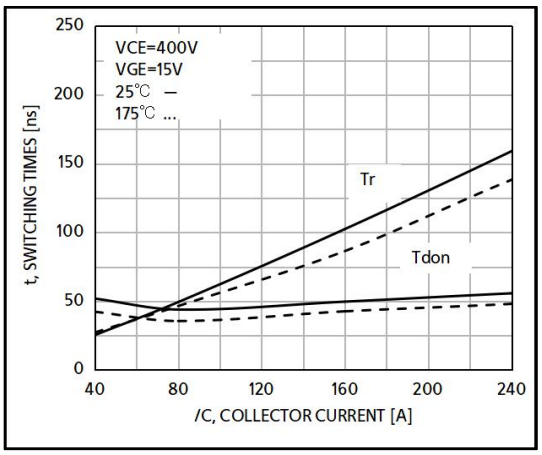


Figure 13. Switching Time-IC Characteristics

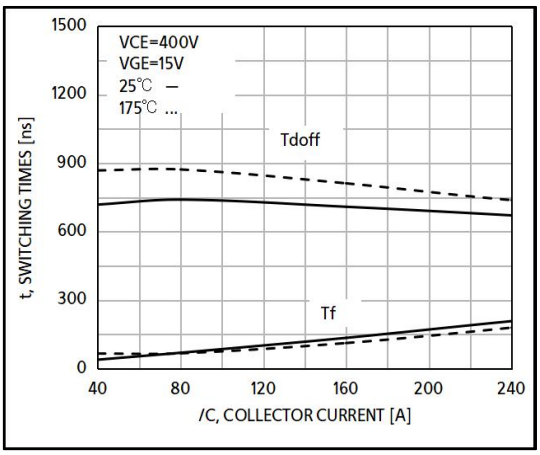


Figure 14. Switching Time-IC Characteristics

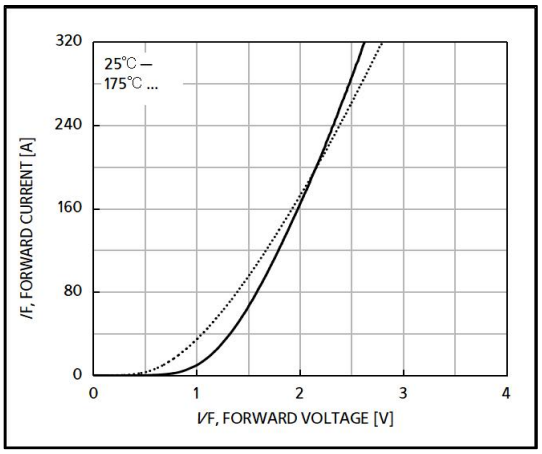


Figure 15. Diode Forward Characteristics

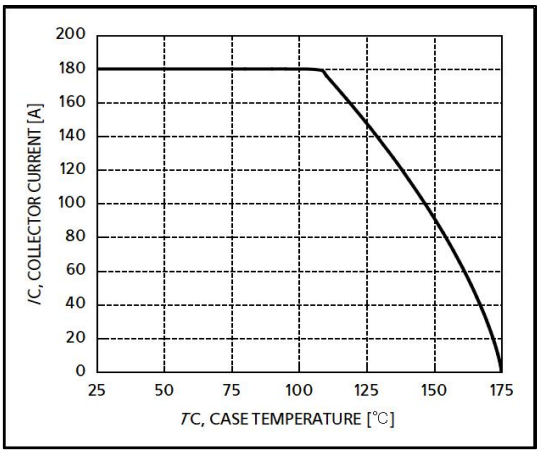


Figure 16. Collector Current-Tc Characteristics
(Tj ≤175℃)

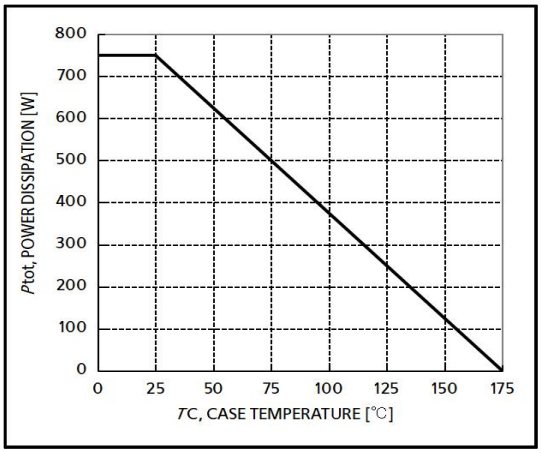


Figure 17. Power Dissipation-Tc Characteristics
(Tj ≤175℃)

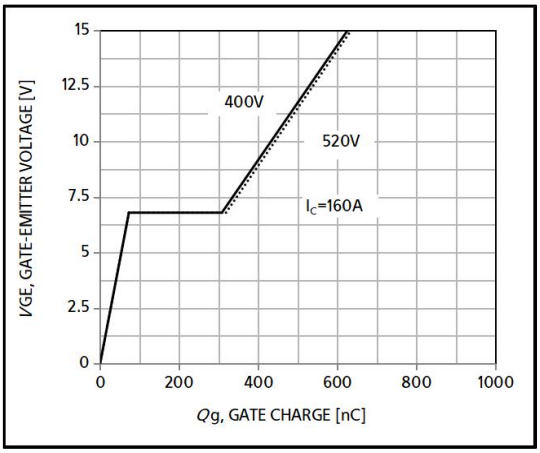


Figure 18. Gate Charge Characteristics

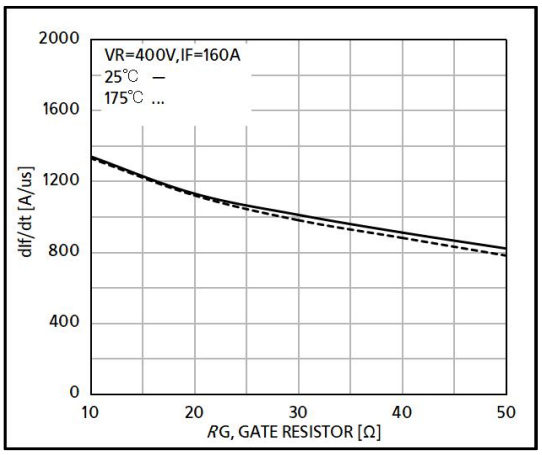


Figure 19. Typical diode current slope as a function of gate resistor

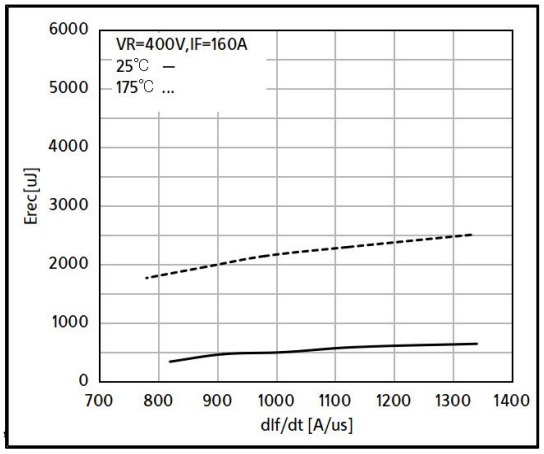


Figure 20. Typical reverse recovery Energy as a function of diode current slope

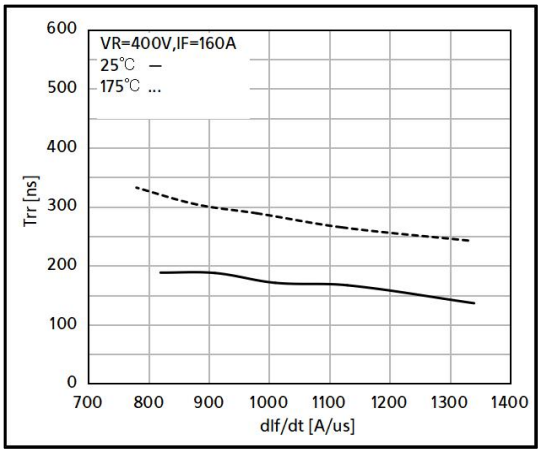


Figure 21. Typical reverse recovery time as a function of diode current slope

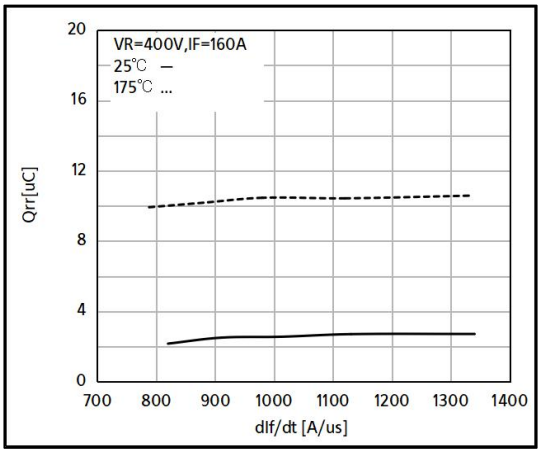


Figure 22. Typical reverse recovery charge as a function of diode current slope

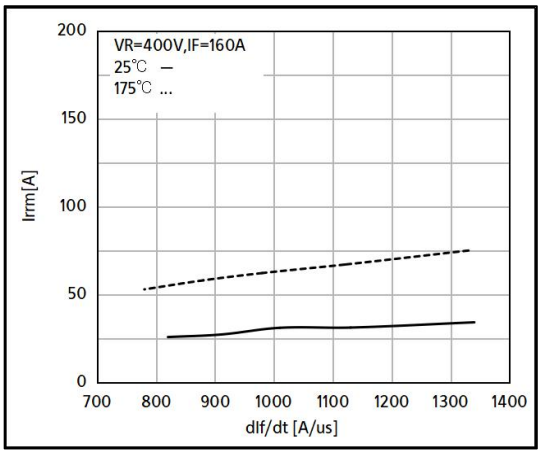


Figure 23. Typical reverse recovery current as a function of diode current slope

Typical Performance Characteristics

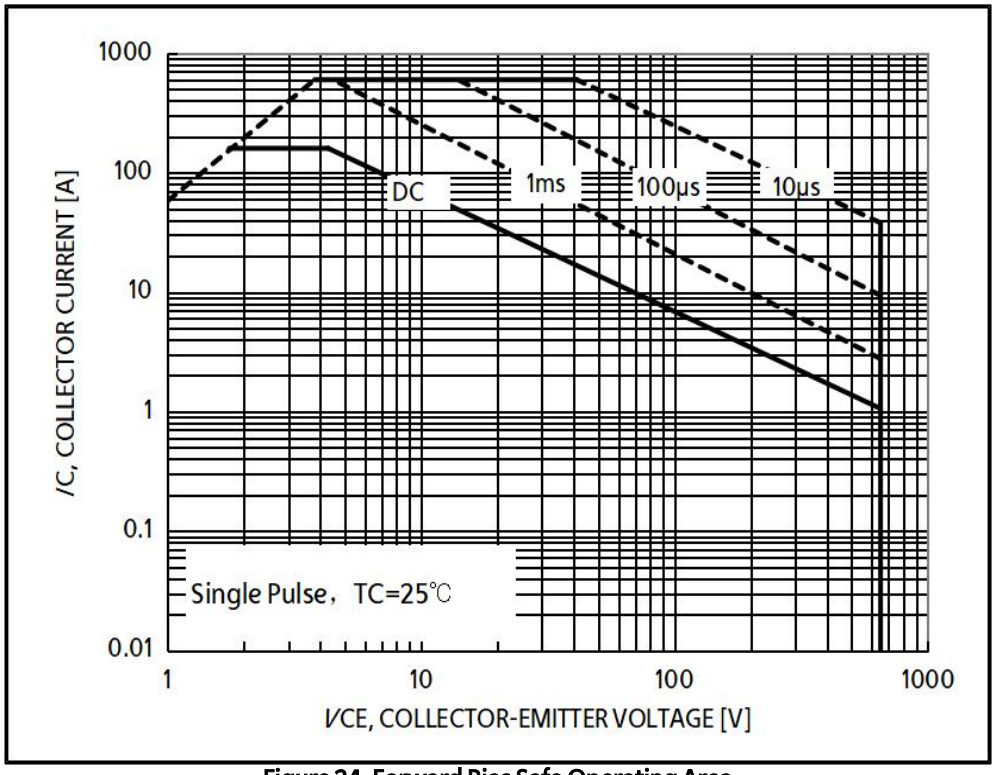


Figure 24. Forward Bias Safe Operating Area

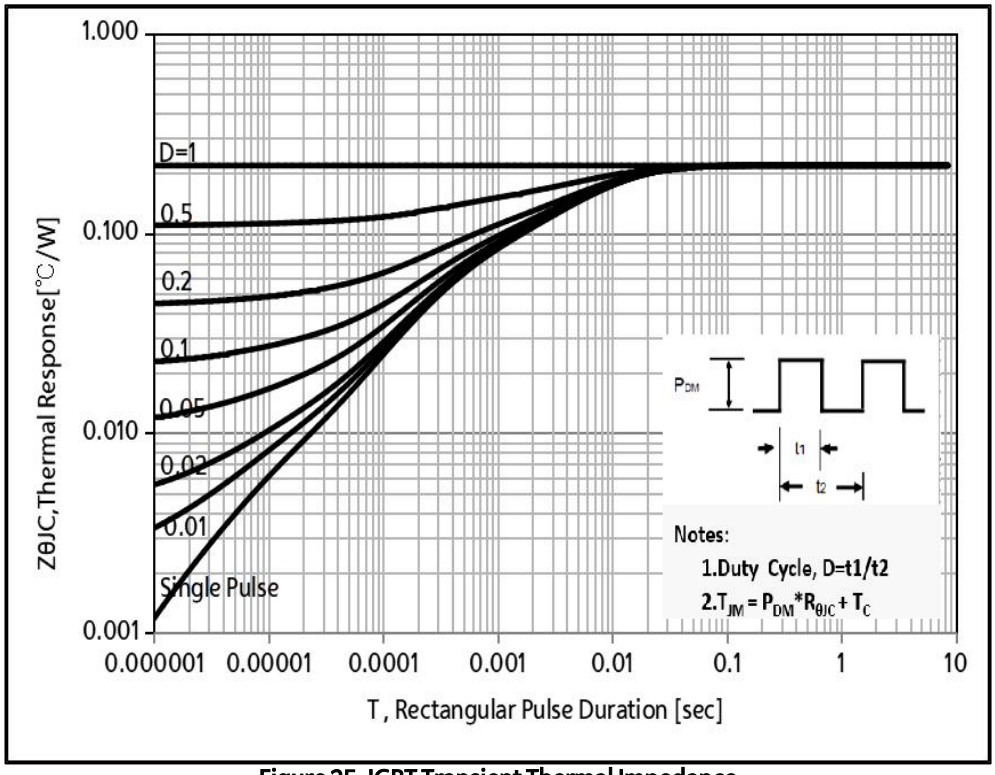
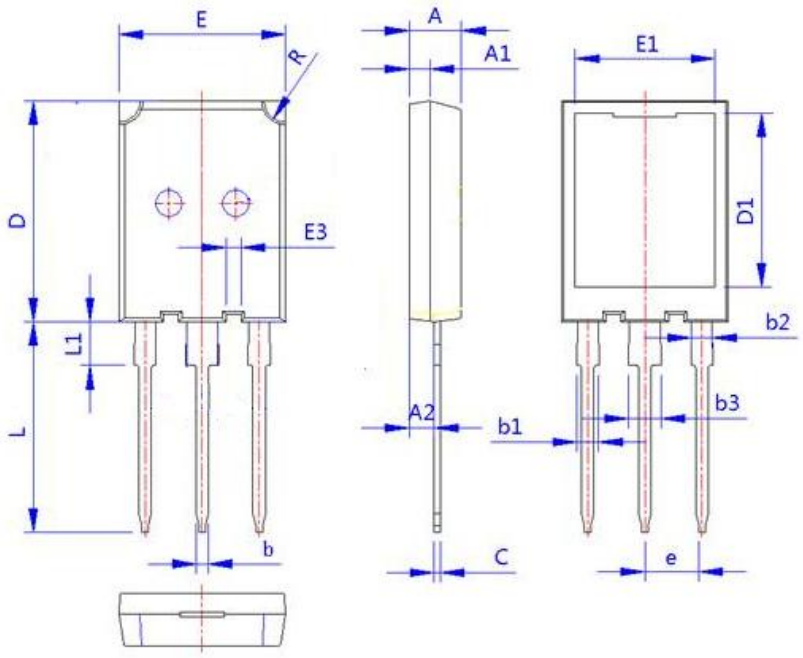


Figure 25. IGBT Transient Thermal Impedance

Package Information



Items	Values(mm)	
	MIN	MAX
A	4.85	5.15
A1	1.85	2.15
A2	2.15	2.65
b	1.07	1.33
b1	1.90	2.46
b2	1.90	2.16
b3	2.82	3.43
C	0.55	0.70
D	20.75	21.15
D1	16.20	16.90
E	15.50	16.10
E1	13.01	13.51
E3	1.25	1.65
e	5.44(BSC)	
R	1.80	2.20
L	19.60	20.40
L1	4.00	4.48

TO-247PLUS Package

The name and content of poisonous and harmful material in products

Part's Name Limit	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DIBP	DEHP	DBP	BBP
	⩽ 0.1%	⩽ 0.1%	⩽ 0.01 %	⩽ 0.1%	⩽ 0.1%	⩽ 0.1%	⩽ 0.1%	⩽ 0.1%	⩽ 0.1%	⩽ 0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	○：Means the hazardous material is under the criterion of 2011/65/EU. ×：Means the hazardous material exceeds the criterion of 2011/65/EU. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.									

Warnings

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. IGBTs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

WUXI CHINA RESOURCES HUAJING MICROELECTRONICS CO., LTD.

Add： No.14 Liangxi RD. Wuxi, Jiangsu, China Mail：214061 Tel: 0510-85807228
Fax: 0510-85800864

Marketing Part： Post：214061 Tel / Fax：0510-85807228-3663/5508
0510-85800360（Fax）

Application and Service：Post：214061 Tel / Fax：0510-85807228-3399 / 2227

Revison History		
Revision	Date	Major changes
1.0	2025/11/6	Initial release